

A1
Cont.

feature printed on said structure.

8. (Amended) A method of trimming a conductor on a substrate, comprising:

providing a conductor having a first critical dimension;

forming a lithographic pattern on said conductor;

etching said conductor with an O₂-containing material to trim said first critical dimension to a second critical dimension, said second critical dimension being smaller than said first critical dimension; and

correcting an offset between a nested feature printed on said structure and an isolated feature printed on said structure.

A2